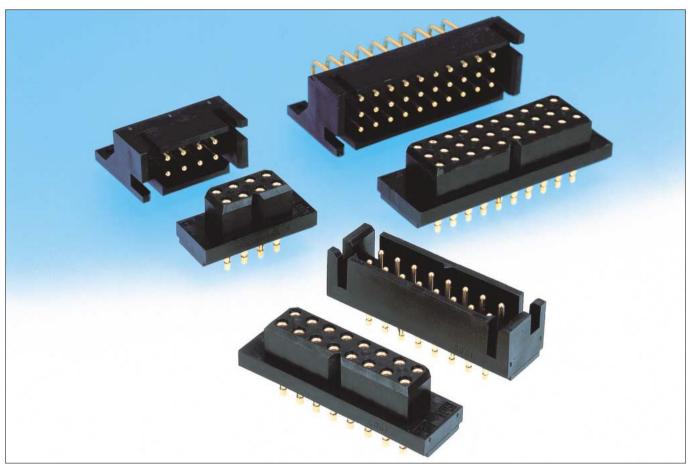


# **High Current, High Density, Power Connectors**

MCN51 Series



#### **■**Features

1. High Current Applications

Board-to-board connectors are UL certified for 27 A per contact.

2. Hirose's Unique Compliant Press-fit connection to the PCB (patents pending)

The compliant section is designed to provide reliable and damage free connection with the Plated-Through-hole, reducing stresses to the PCB.

- 3. Multiple Contacts in a Variety of Configurations offered with 8, 16 and 30 contacts in vertical, right angle, solder and compliant press-fit terminations.
- 4. UL Recognized, CSA Certified

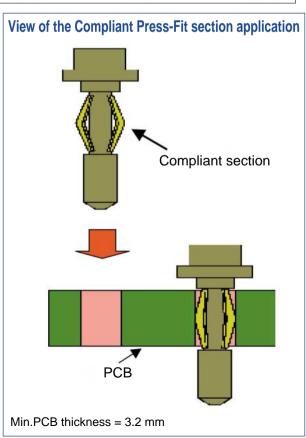
UL File No. E52653 CSA File No. LR95109





#### ■ Applications

Telecom, LAN and Data storage equipment, high-end servers, and a wide variety of power supply devices.



**■**Product Specifications

	Current rating	Operating temperature range	Storage temperature range
	27 A max. (Note 1)	-55°C to +125°C (Note 2)	-10°C to +60°C (Note 3)
Ratings	Voltage rating 600 V AC	Operating humidity level Relative humidity 95% max.	Storage humidity range 40% to +70%
	000 7 70	(provided there is no condensation)	4070 10 17 070

Item	Specification	Conditions
1.Insulation resistance	5000M ohms min.	500 V DC
2.Withstanding voltage	No flashover or insulation breakdown.	2000V AC applied /one minute
3.Contact resistance	3m ohms max. (initial value)	25 A DC
4.Vibration	No electrical discontinuity of 1 ms or more	Frequency of 10 to 2,000 Hz, overall amplitude of 1.5 mm
4. VIDIALION	No damage, cracks, or parts dislocation.	Or, acceleration of 196 m/s <sup>2</sup> for 2 hours in each of 3 directions.
5.Heat resistance	Contact resistance: 7m ohms max.	Expose to a temperature of +125°C for 96 hours.
6.Cold resistance	Contact resistance: 7m ohms max.	Expose to a temperature of -55°C for 96 hours.
	Contact resistance: 7m ohms max.	(-55°C: 30 minutes => 15 to 30°C: 5 minutes max. =>
7.Temperature cycle	Insulation resistance: 5000M ohms min.	125°C: 30 minutes => 15 to 30°C: 5 minutes max.)
	No damage, cracks, or parts dislocation.	20 cycles
9 Humidity recistance	Contact resistance: 7m ohms max.	56 days at temperature of 40°C±2°C and humidity of 90% to
8. Humidity resistance Insulation resistance: 5000 M ohms min.		95%
9. High temperature exposure	Contact resistance: 7m ohms max.	1500 hours at temperature of 85℃
10.Operating life	Contact resistance: 7m ohms max.	1000 cycles
11.Sulfur dioxide gas	Contact resistance: 7m ohms max.	Leave for 96 hours in an atmosphere of 25 ppm
11.Sullul dioxide gas	Contact resistance. Thi offins max.	concentration sulfur dioxide gas.

Note1: Refer to "Current-Temperature De-rating Curve" (IEC 512-3, Test 5b) and "Temperature Rise Curve" (IEC 512-3 Test 5a) on Page 3.

Note2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating Temperature Range and Humidity range covers non- conducting condition of installed connectors in storage, shipment or during transportation.

#### **■**Materials

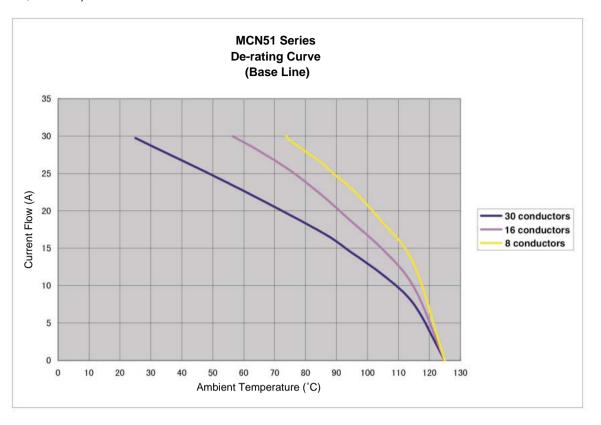
Product	Part	Material	Finish	Remarks
Die boodere	Insulator	PBT	Black	UL94V-0
Pin headers	Contacts	Copper alloy	Gold plating	
Desentantes	Insulator	PBT	Black	UL94V-0
Receptacles	Contacts	Copper alloy	Gold plating	

### **■**Ordering Information

Series name : MCN51	4 Rows 2:2 rows
Number of contacts : 8, 16, 30	3: 3 rows
Connector type P: Pin header	6 Contact type
S : Socket Receptacle	PFA : Press-fit (through-hole diameter 2.03 mm)
	DS : Right-angle through-hole type

### **●** Current - Temperature De-rating Curve

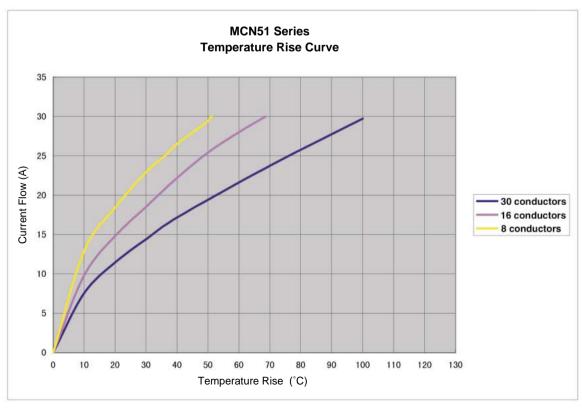
●(IEC 512-3, Test 5b)



Measurements were made with 12 AWG wire connected in series to all contacts.

#### **◆**Temperature Rise Curve

●(IEC 512-3, Test 5a)



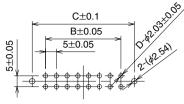
Measurements were made with 12 AWG wire connected in series to all contacts.

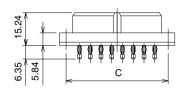
#### ■Receptacle: Straight, Press-Fit

#### ●2-row type



# PCB mounting pattern







Copper plating thickness :  $70 \pm 10 \mu m$ Solder plating thickness : 5 to 10  $\mu$ m Board thickness : 3.2 mm min. Fasten to the board being sure to use (American type) #2 tapping screws.

Recommended Through-Hole Diameter Finished hole : 2.03 dia.  $\pm$  0.05 mm

**Drill diameter** :  $2.185 \, \text{dia.} \pm 0.025 \, \text{mm}$ 

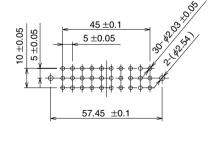
63.65

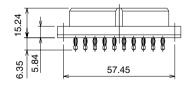
Part Number	CL No.	А	В	С	No.of Contacts(D)
MCN51-8S2-PFA	589-0200-6	33.63	15	27.43	8
MCN51-16S2-PFA	589-0199-9	53.64	35	47.45	16

#### ●3-row type



#### PCB mounting pattern







Copper plating thickness : 70  $\pm$  10  $\mu$ m Solder plating thickness : 5 to 10  $\mu$ m Board thickness : 3.2 mm min. Fasten to the board being sure to use (American type) #2 tapping screws.

Recommended Through-Hole Diameter

Finished hole :  $2.03 \, dia. \pm 0.05 \, mm$ : 2.185 dia. ± 0.025 mm Drill diameter

Part Number	CL No.	No. of Contacts
MCN51-30S3-PFA	589-0196-0	30

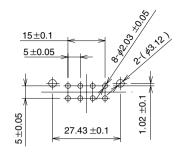
# **■**Pin Header: Right-Angle Through-hole

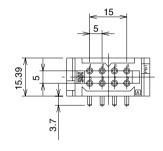
## ●2-row type

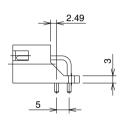


# 33.63 27.43 15.24

#### PCB mounting pattern

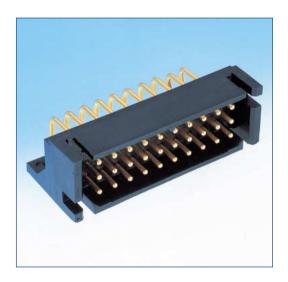




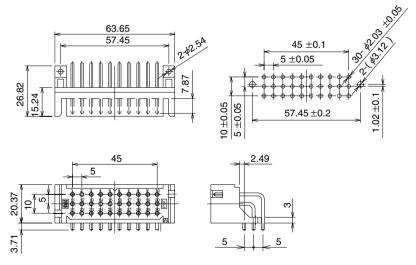


Part Number	CL No.	No. of Contacts
MCN51-8P2-DS	589-0202-1	8

#### ●3-row type



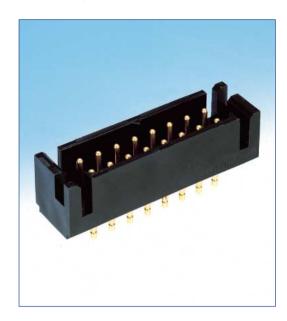
### PCB mounting pattern



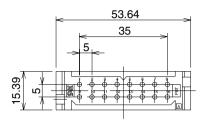
Part Number	CL No.	No. of Contacts
MCN51-30P3-DS	589-0195-8	30

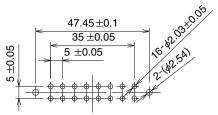
### **■**Pin Header: Straight, Press-Fit

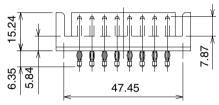
#### ●2-row type

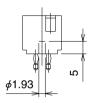


#### PCB mounting pattern









Copper plating thickness :  $70 \pm 10 \mu m$ Solder plating thickness: 5 to 10  $\mu$ m Board thickness : 3.2 mm min. Fasten to the board being sure to use (American type) #2 tapping screws.

Recommended Through-Hole Diameter

Finished hole : 2.03 dia.  $\pm$  0.05 mm Drill diameter : 2.185 dia.  $\pm$  0.025 mm

Part Number	CL No.	No. of Contacts
MCN51-16P2-PFA	589-0201-9	16